Chapter 4 Low-Power VLSI Design

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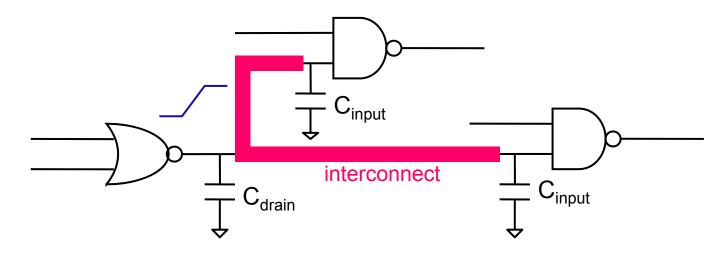
Outline

- Introduction
- Low-Power Gate-Level Design
- Low-Power Architecture-Level Design
- Algorithmic-Level Power Reduction
- RTL Techniques for Optimizing Power

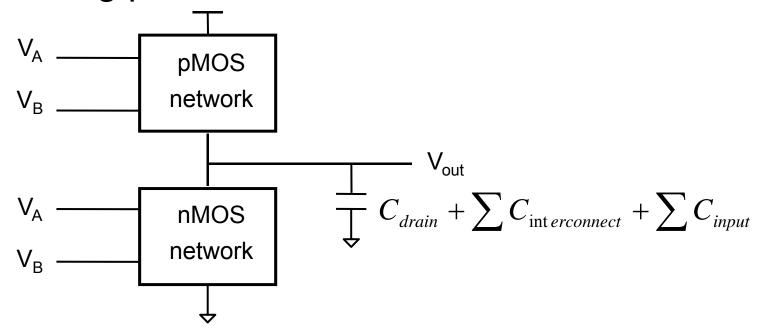
Introduction

- Most SOC design teams now regard power as one of their top design concerns
- Why low-power design?
 - Battery lifetime (especially for portable devices)
 - Reliability
- Power consumption
 - Peak power
 - Average power

- Average power consumption
 - Dynamic power consumption
 - Short-circuit power consumption
 - Leakage power consumption
 - Static power consumption
- Dynamic power dissipation during switching



 Generic representation of a CMOS logic gate for switching power calculation



$$P_{avg} = \frac{1}{T} \left[\int_{0}^{T/2} V_{out} \left(-C_{load} \frac{dV_{out}}{dt} \right) dt + \int_{T/2}^{T} (V_{DD} - V_{out}) \left(C_{load} \frac{dV_{out}}{dt} \right) dt \right]$$

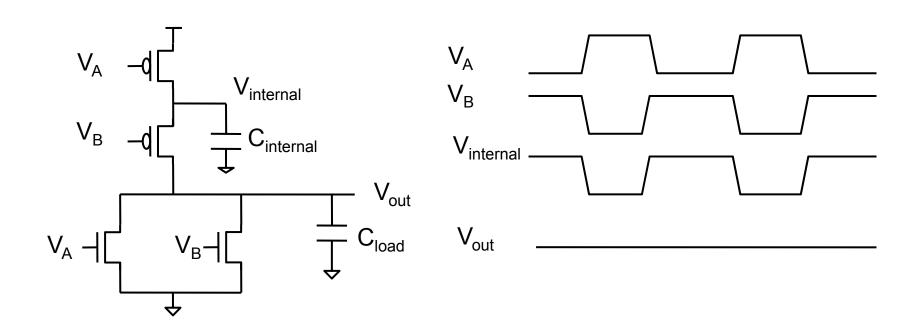
The average power consumption can be expressed as

$$P_{avg} = \frac{1}{T} C_{load} V_{DD}^{2} = C_{load} V_{DD}^{2} f_{CLK}$$

• The node transition rate can be slower than the clock rate. To better represent this behavior, a node transition factor (α_T) should be introduced

$$P_{avg} = \alpha_T C_{load} V_{DD}^2 f_{CLK}$$

 The switching power expressed above are derived by taking into account the output node load capacitance



The generalized expression for the average power dissipation can be rewritten as

$$P_{avg} = \left(\sum_{i=1}^{\# of nodes} \alpha_{Ti} C_i V_i\right) V_{DD} f_{CLK}$$

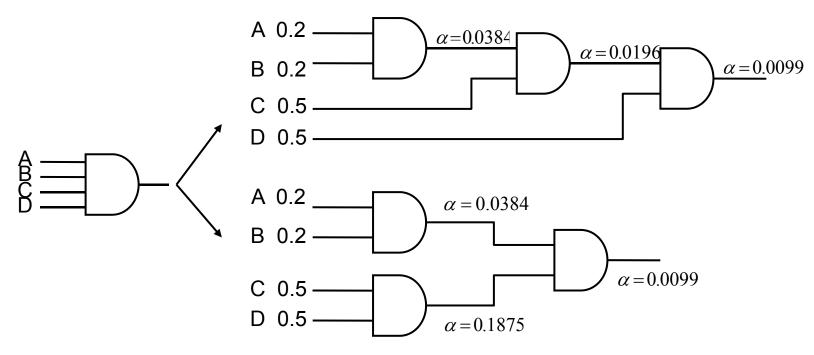
Gate-Level Design — Technology Mapping

- The objective of logic minimization is to reduce the boolean function.
- For low-power design, the signal switching activity is minimized by restructuring a logic circuit
- The power minimization is constrained by the delay, however, the area may increase.
- During this phase of logic minimization, the function to be minimized is

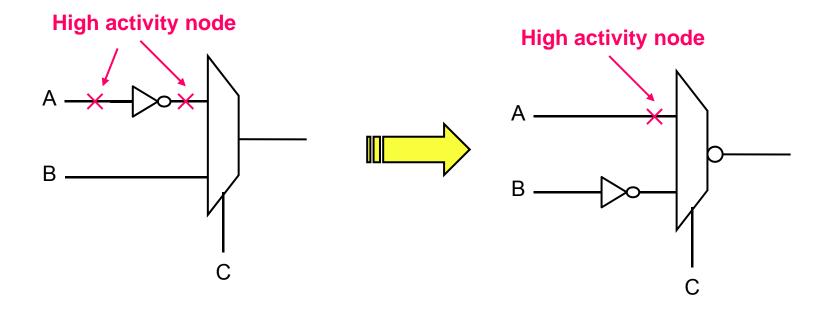
$$\sum_{i} P_{i} (1 - P_{i}) C_{i}$$

Gate-Level Design — Technology Mapping

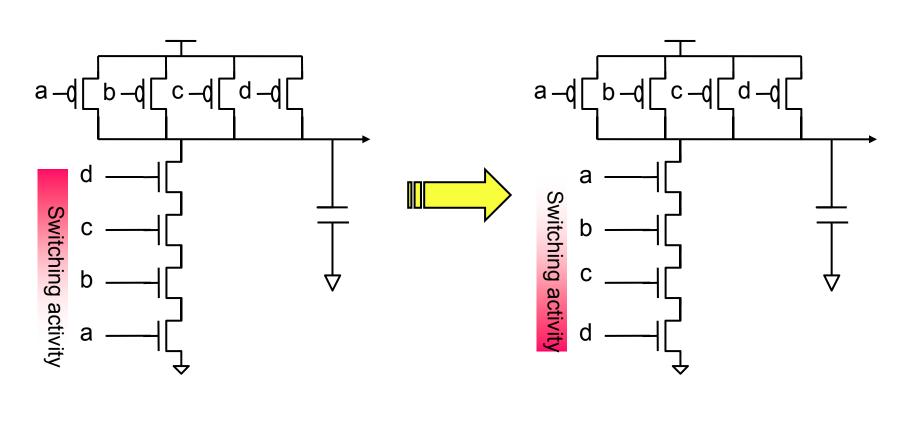
- The first step in technology mapping is to decompose each logic function into two-input gates
- The objective of this decomposition is to minimizing the total power dissipation by reducing the total switching activity

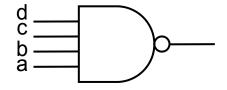


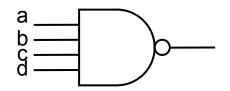
Gate-Level Design — Phase Assignment



Gate-Level Design — Pin Swapping

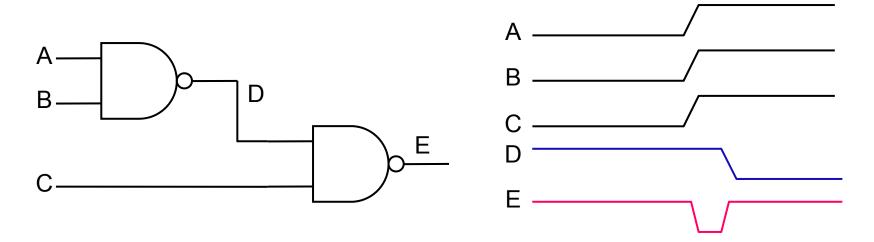






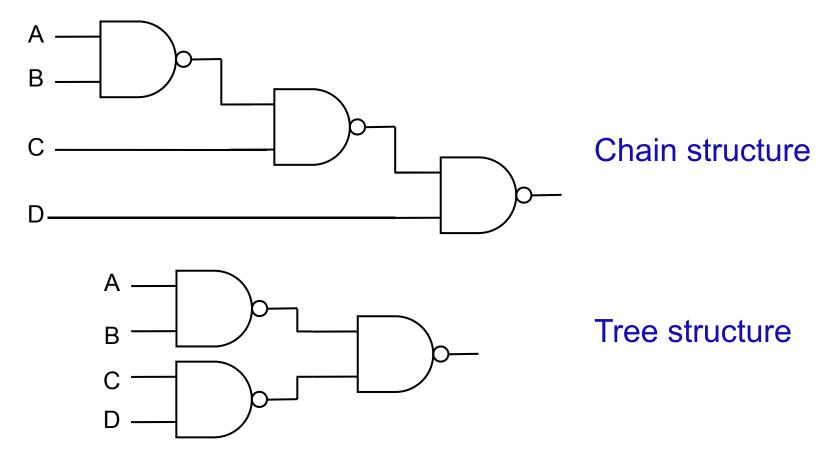
Gate-Level Design – Glitching Power

- Glitches
 - spurious transitions due to imbalanced path delays
- A design has more balanced delay paths
 - has fewer glitches, and thus has less power dissipation
- Note that there will be no glitches in a dynamic CMOS logic

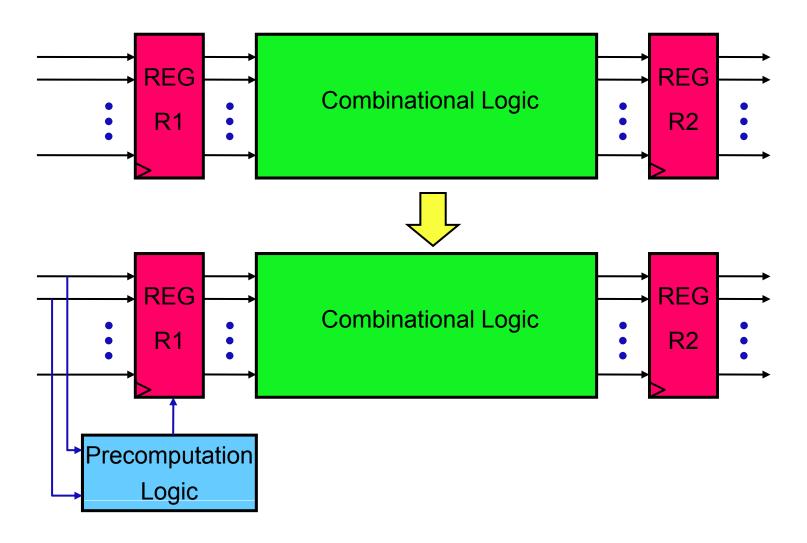


Gate-Level Design – Glitching Power

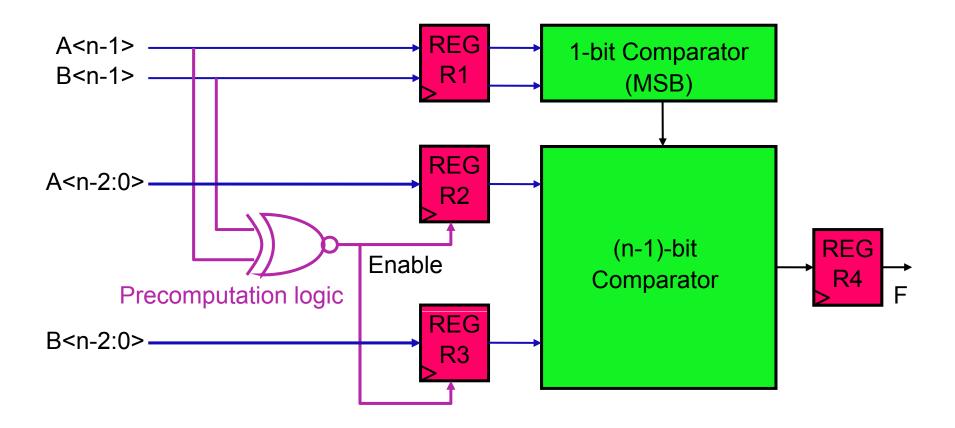
- A chain structure has more glitches
- A tree structure has fewer glitches



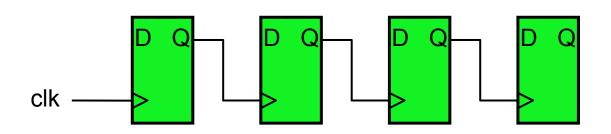
Gate-Level Design - Precomputation



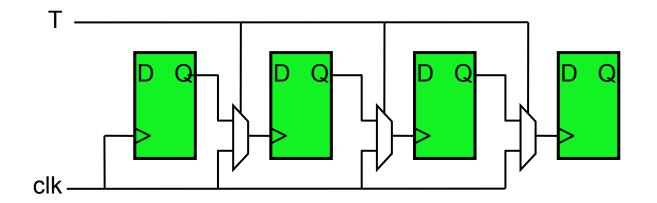
Gate-Level Design - Precomputation



Gate-Level Design – Gating Clock

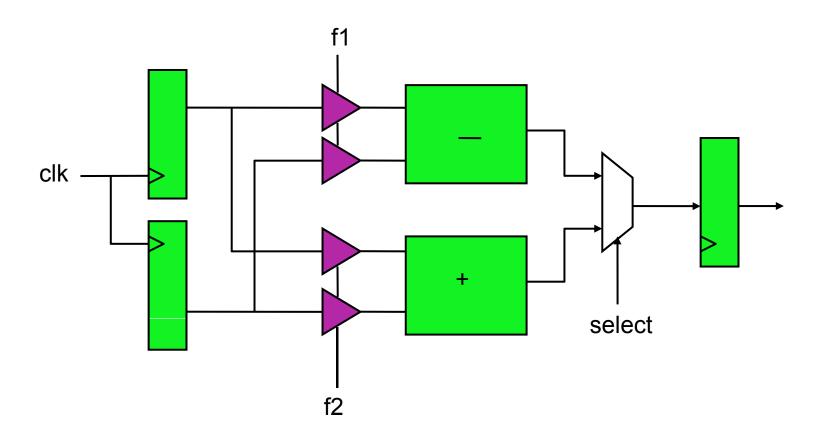


Fail DFT rule checking

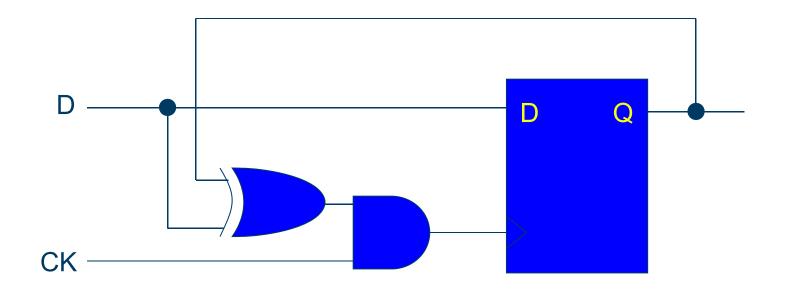


Add control pin to solve DFT violation problem

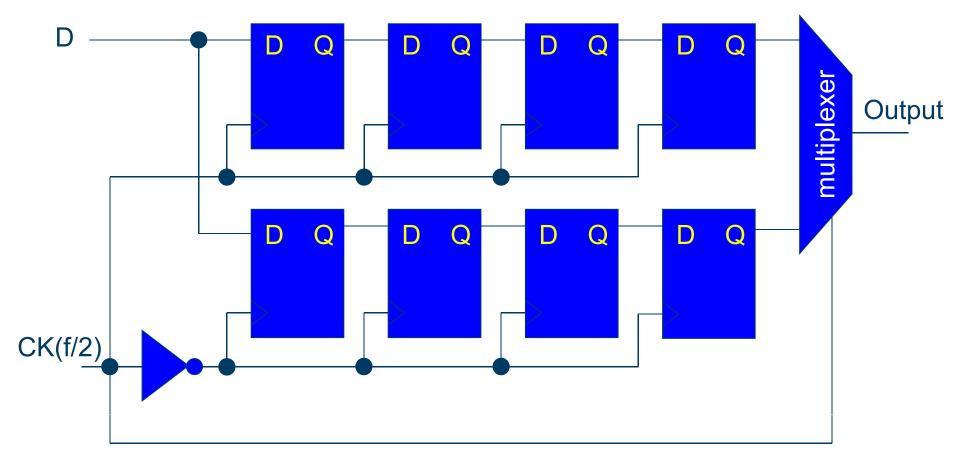
Gate-Level Design — Input Gating



Clock-Gating in Low-Power Flip-Flop



Reduced-Power Shift Register



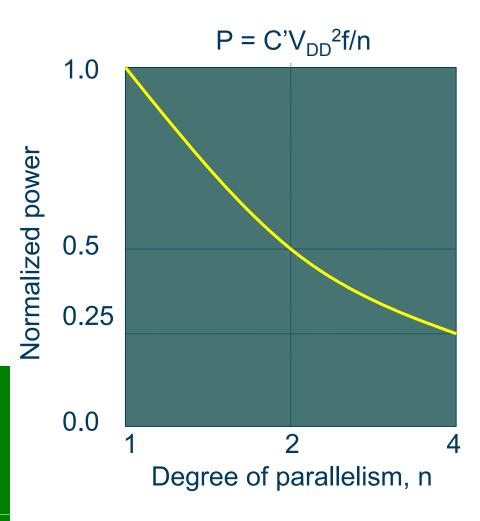
Flip-flops are operated at full voltage and half the clock frequency.

Power Consumption of Shift Register

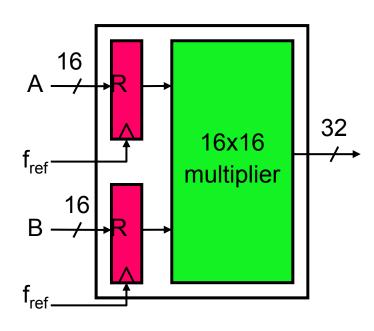
16-bit shift register, 2µ CMOS

| Deg. Of parallelism | Freq (MHz) | Power (µW) |
|---------------------|---------------|---------------|
| 1 | 33.0 | 1535 |
| 2 | 16.5 | 887 |
| 4 | 8.25 | 738 |

C. Piguet, "Circuit and Logic Level Design," pages 103-133 in W. Nebel and J. Mermet (ed.), Low Power Design in Deep Submicron Electronics, Springer, 1997.

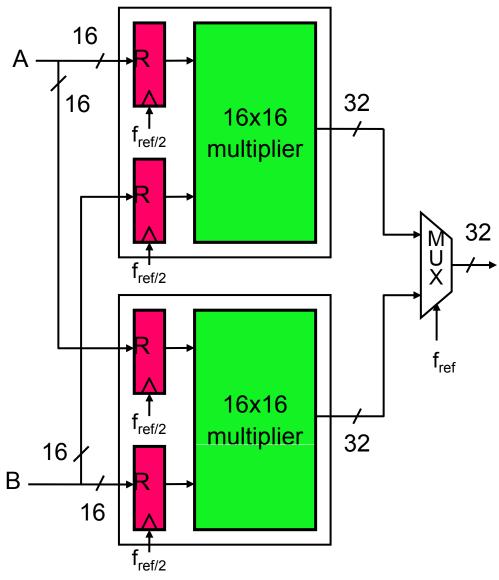


Architecture-Level Design — Parallelism



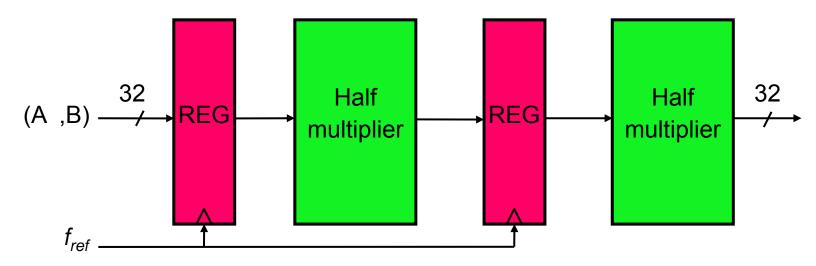
Assume that With the same 16x16 multiplier, the power supply can be reduced from V_{ref} to $V_{ref}/1.83$.

$$P_{parallel} = 2.2C_{ref} \left(\frac{V_{ref}}{1.83}\right)^2 \frac{f_{ref}}{2} = 0.33P_{ref}$$



Architecture-Level Design - Pipelining

The hardware between the pipeline stages is reduced then the reference voltage V_{ref} can be reduced to V_{new} to maintain the same worst case delay. For example, let a 50MHz multiplier is broken into two equal parts as shown below. The delay between the pipeline stages can be remained at 50MHz when the voltage V_{new} is equal to $V_{ref}/1.83$

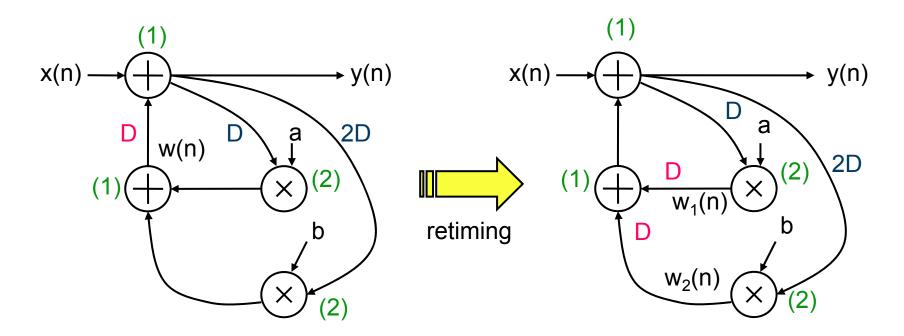


$$P_{pipeline} = 1.2C_{ref} \left(\frac{V_{ref}}{1.83}\right)^2 f_{ref} = 0.36P_{ref}$$

Architecture-Level Design – Retiming

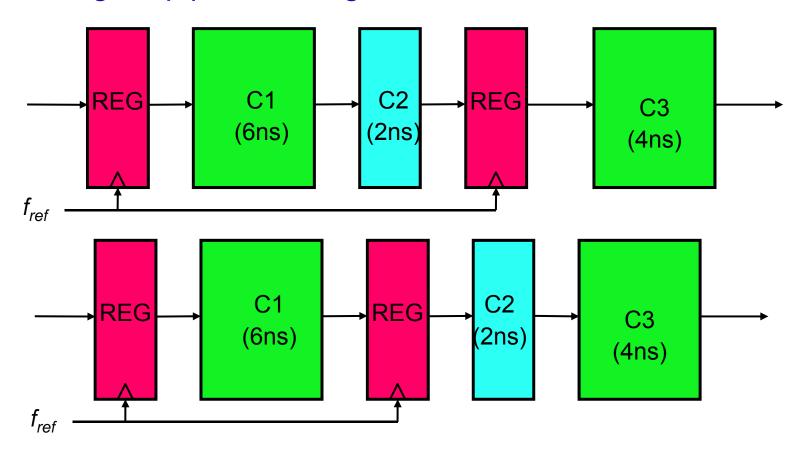
Retiming is a transformation technique used to change the locations of delay elements in a circuit without affecting the input/output characteristics of the circuit.

Two versions of an IIR filter.

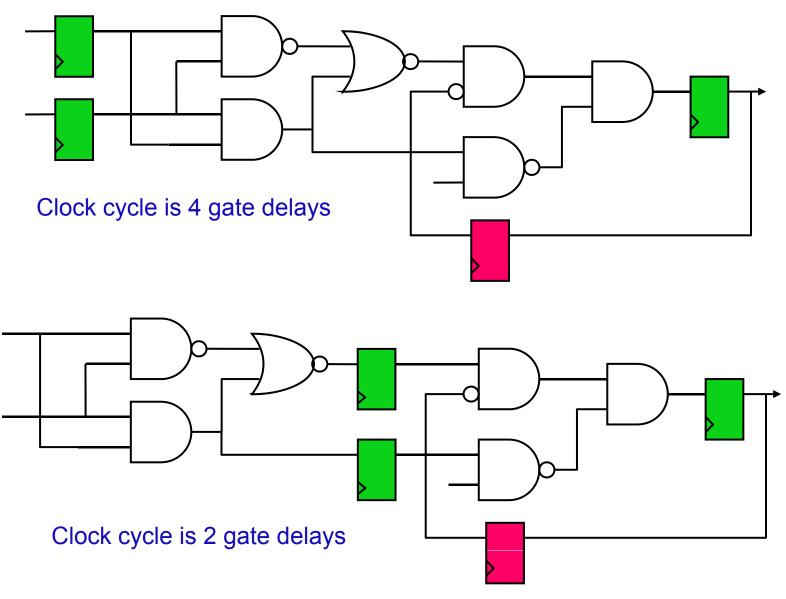


Architecture-Level Design - Retiming

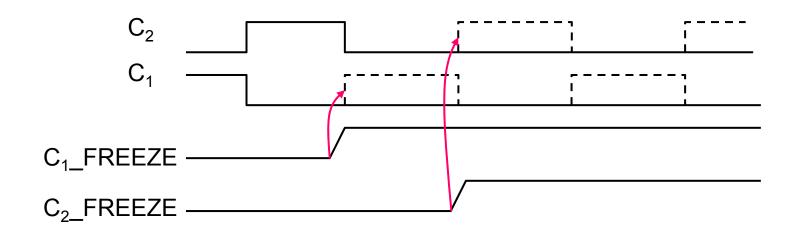
Retiming for pipeline design

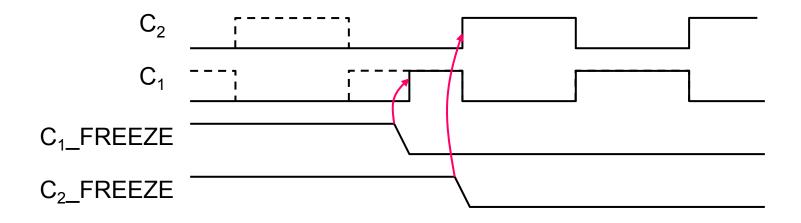


Architecture-Level Design - Retiming



Architecture-Level Design – *Power Management*

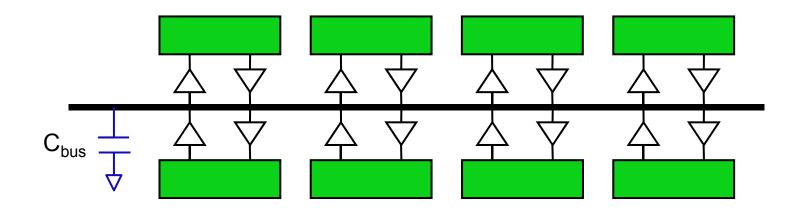


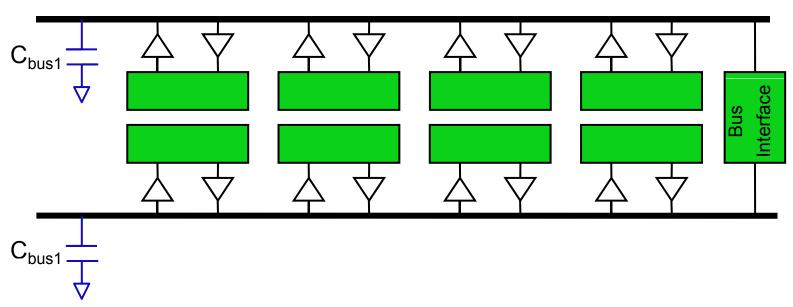


Architecture-Level Design — Bus Segmentation

- Avoid the sharing of resources
 - Reduce the switched capacitance
- For example: a global system bus
 - A single shared bus is connected to all modules, this structure results in a large bus capacitance due to
 - The large number of drivers and receivers sharing the same bus
 - * The parasitic capacitance of the long bus line
- A segmented bus structure
 - Switched capacitance during each bus access is significantly reduced
 - Overall routing area may be increased

Architecture-Level Design — Bus Segmentation





Algorithmic-Level Design – factivity Reduction

Minimization the switching activity, at high level, is one way to reduce the power dissipation of digital processors.

One method to minimize the switching signals, at the algorithmic level, is to use an appropriate coding for the signals rather than straight binary code.

The table shown below shows a comparison of 3-bit representation of the binary and Gray codes.

| Binary Code | Gray Code | Decimal Equivalent |
|-------------|-----------|--------------------|
| 000 | 000 | 0 |
| 001 | 001 | 1 |
| 010 | 011 | 2 |
| 011 | 010 | 3 |
| 100 | 110 | 4 |
| 101 | 111 | 5 |
| 110 | 101 | 6 |
| 111 | 100 | 7 |

State Encoding for a Counter

- Two-bit binary counter:
 - * State sequence, $00 \rightarrow 01 \rightarrow 10 \rightarrow 11 \rightarrow 00$
 - * Six bit transitions in four clock cycles
 - * 6/4 = 1.5 transitions per clock
- Two-bit Gray-code counter
 - * State sequence, $00 \rightarrow 01 \rightarrow 11 \rightarrow 10 \rightarrow 00$
 - * Four bit transitions in four clock cycles
 - *4/4 = 1.0 transition per clock
- Gray-code counter is more power efficient.

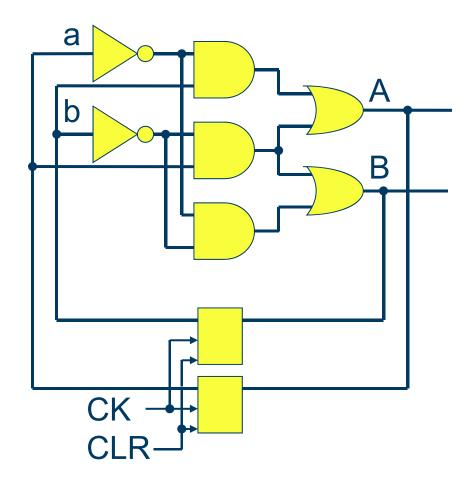
G. K. Yeap, Practical Low Power Digital VLSI Design, Boston:

Binary Counter: Original Encoding

| Pres sta | sent ate | Next | state |
|-------------|-------------|------|-------|
| а | b | Α | В |
| 0 | 0 | 0 | 1 |
| 0 | 1 | 1 | 0 |
| 1 | 0 | 1 | 1 |
| 1 | 1 | 0 | 0 |

$$A = a'b + ab'$$

 $B = a'b' + ab'$

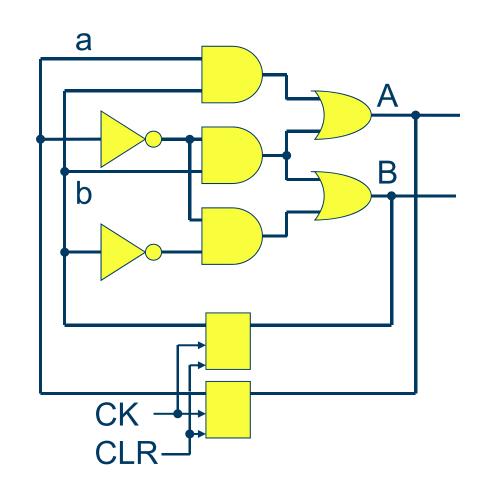


Binary Counter: Gray Encoding

| Present state | | Next state | |
|------------------|---|------------|---|
| а | b | Α | В |
| 0 | 0 | 0 | 1 |
| 0 | 1 | 1 | 1 |
| 1 | 0 | 0 | 0 |
| 1 | 1 | 1 | 0 |

$$A = a'b + ab$$

 $B = a'b' + a'b$



Three-Bit Counters

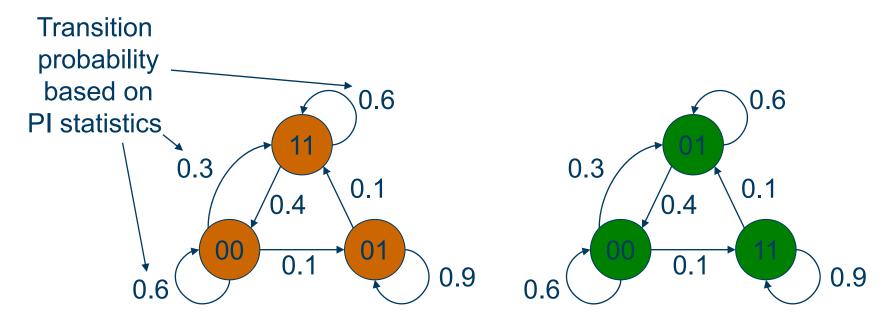
| Binary | | Gray-code | |
|------------------------------|----------------|-----------|-------------------|
| State | No. of toggles | State | No. of toggles |
| 000 | - | 000 | - |
| 001 | 1 | 001 | 1 |
| 010 | 2 | 011 | 1 |
| 011 | 1 | 010 | 1 |
| 100 | 3 | 110 | 1 |
| 101 | 1 | 111 | 1 |
| 110 | 2 | 101 | 1 |
| 111 | 1 | 100 | 1 |
| 000 | 3 | 000 | 1 |
| Av. Transitions/clock = 1.75 | | Av. Tran | sitions/clock = 1 |

N-Bit Counter: Toggles in Counting Cycle

- Binary counter: $T(binary) = 2(2^N 1)$
- Gray-code counter: $T(gray) = 2^{N}$
- $T(gray)/T(binary) = 2^{N-1}/(2^N 1) \rightarrow 0.5$

| Bits | T(binary) | T(gray) | T(gray)/T(binary) |
|------|-----------|---------|-------------------|
| 1 | 2 | 2 | 1.0 |
| 2 | 6 | 4 | 0.6667 |
| 3 | 14 | 8 | 0.5714 |
| 4 | 30 | 16 | 0.5333 |
| 5 | 62 | 32 | 0.5161 |
| 6 | 126 | 64 | 0.5079 |
| ∞ | - | - | 0.5000 |

FSM State Encoding



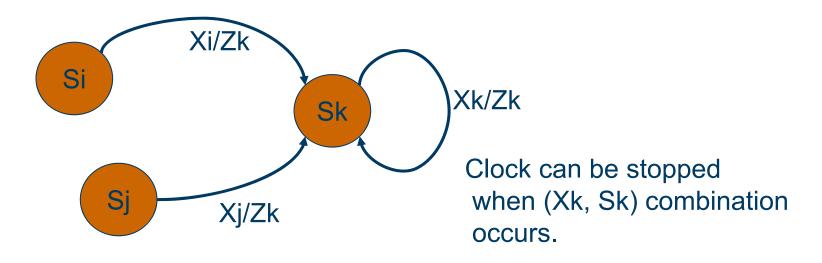
Expected number of state-bit transitions:

$$2(0.3+0.4) + 1(0.1+0.1) = 1.6$$

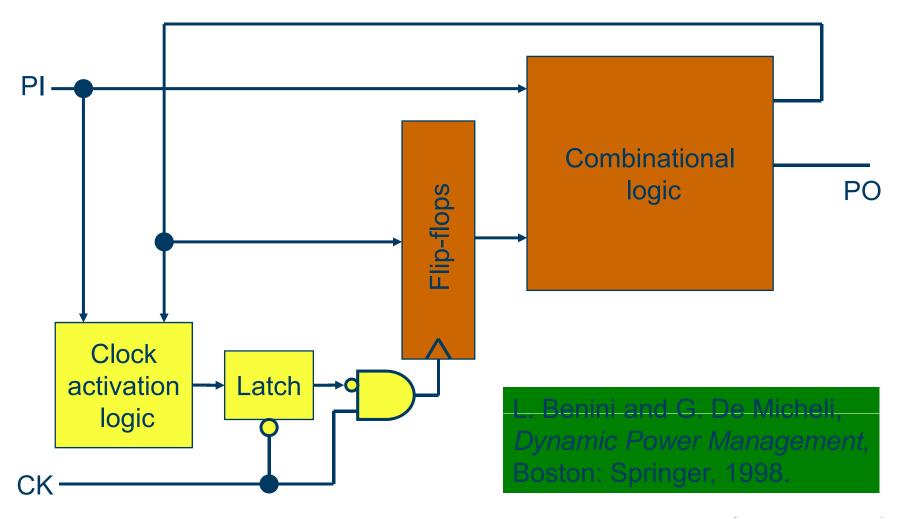
State encoding can be selected using a power-based cost function.

FSM: Clock-Gating

- Moore machine: Outputs depend only on the state variables.
 - -If a state has a self-loop in the state transition graph (STG), then clock can be stopped whenever a self-loop is to be executed.

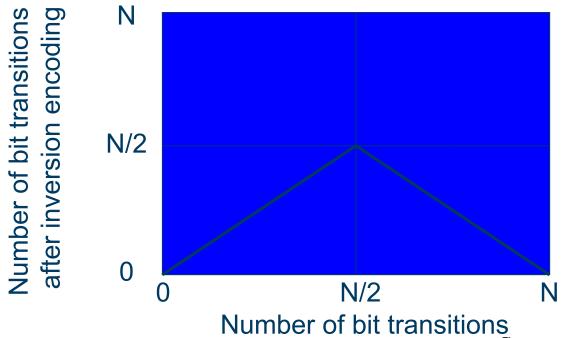


Clock-Gating in Moore FSM

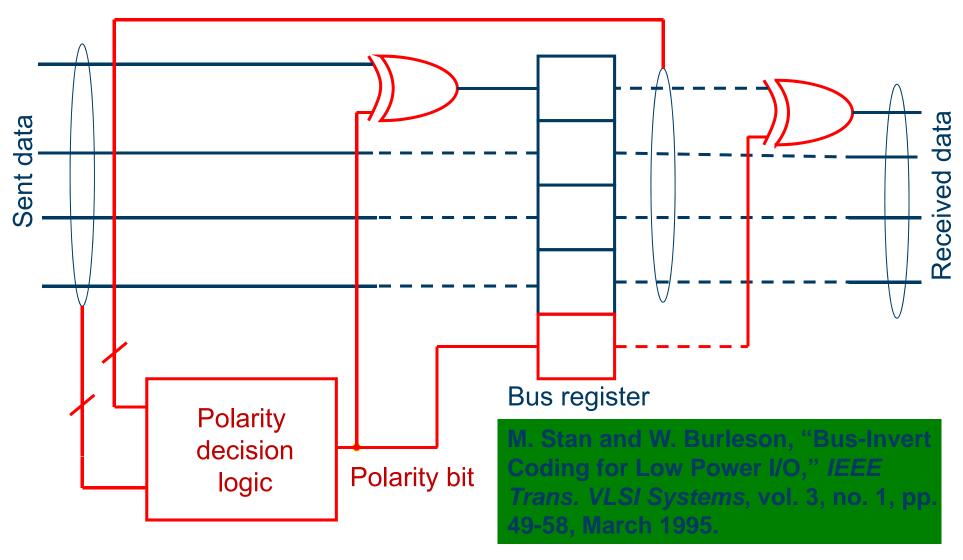


Bus Encoding for Reduced Power

- Example: Four bit bus
 - * $0000 \rightarrow 1110$ has three transitions.
 - * If bits of second pattern are inverted, then 0000 → 0001 will have only one transition.
- Bit-inversion encoding for N-bit bus:



Bus-Inversion Encoding Logic



RTL-Level Design — Signal Gating

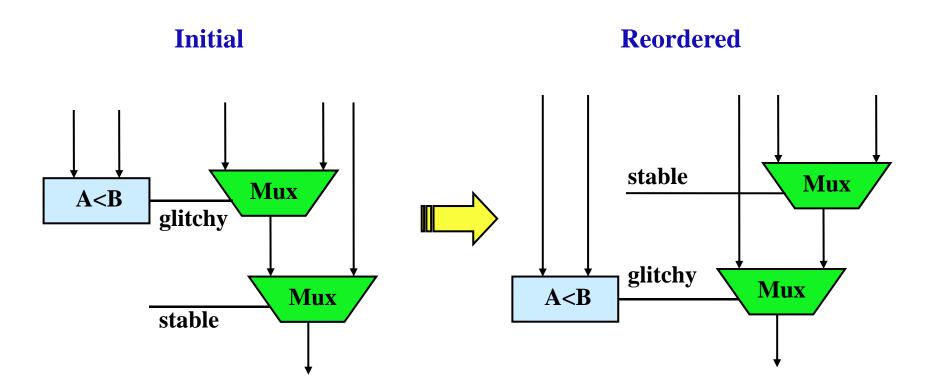
Simple Decoder

```
module decoder (a, sel);
  input [1:0[ a;
  ouput [3:0] sel;
  reg [3:0] sel;
  always @(a) begin
     case (a)
        2'b00: sel=4'b0001;
        2'b01: sel=4'b0010;
        2'b10: sel=4'b0100:
        2'b11: sel=4'b1000;
     endcase
  end
endmodule
```

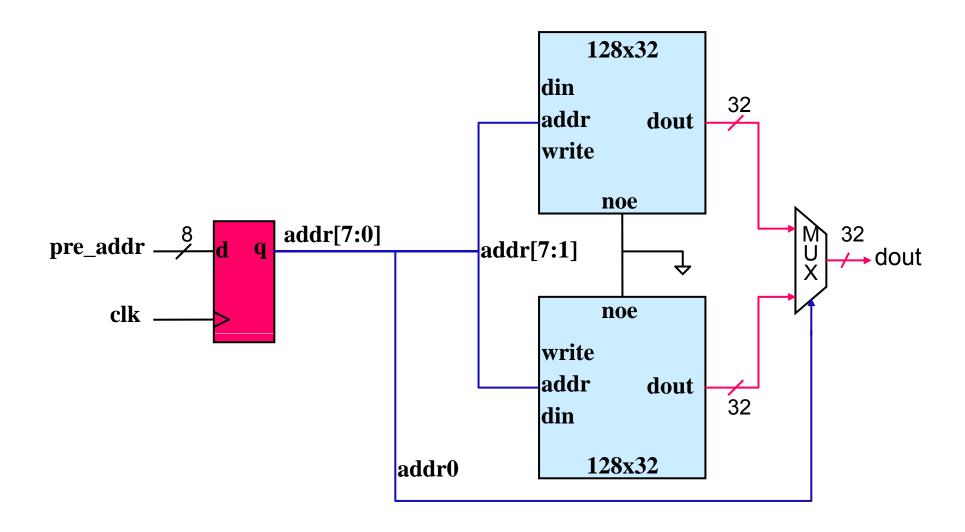
Decoder with enable

```
module decoder (en,a, sel);
  input
              en:
  input [1:0[ a;
  ouput [3:0] sel;
  reg [3:0] sel;
  always @({en,a}) begin
     case ({en,a})
        3'b100: sel=4'b0001;
        3'b101: sel=4'b0010:
        3'b110: sel=4'b0100;
        3'b111: sel=4'b1000;
        default: sel=4'b0000;
     endcase
  end
endmodule
```

RTL-Level Design - Datapath Reordering

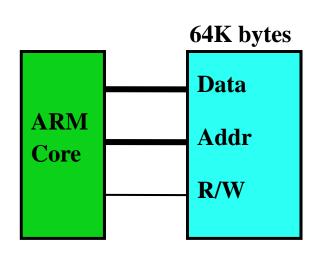


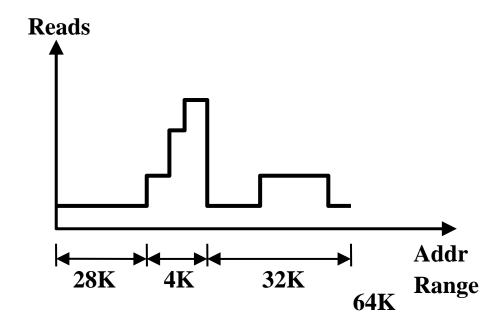
RTL-Level Design — Memory Partition



RTL-Level Design — Memory Partition

Application-driven memory partition





RTL-Level Design — Memory Partition

A power-optimal partitioned memory organization

